Small Signal MOSFET

20 V, 220 mA, Dual N-Channel, 1.0 mm x 1.0 mm SOT-963 Package

Features

- Dual N-Channel MOSFET
- $\bullet \;\; Offers \; a \; Low \; R_{DS(ON)} \; Solution \; in the \; Ultra \; Small \; 1.0 \; x \; 1.0 \; mm \; Package$
- 1.5 V Gate Voltage Rating
- Ultra Thin Profile (< 0.5 mm) Allows It to Fit Easily into Extremely Thin Environments such as Portable Electronics
- This is a Pb-Free Device

Applications

- General Purpose Interfacing Switch
- Optimized for Power Management in Ultra Portable Equipment
- Analog Switch

MAXIMUM RATINGS (T_J = 25°C unless otherwise specified)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V_{DSS}	20	V	
Gate-to-Source Voltage			V_{GS}	±8	V	
Continuous Drain	Steady	$T_A = 25^{\circ}C$		220		
Current (Note 1)	State $T_A = 85^{\circ}C$	I_{D}	160	mA		
	t ≤ 5 s			280		
Power Dissipation	Steady			125		
(Note 1)	State $T_A = 25^{\circ}C$	P_{D}		mW		
t ≤ 5 s				200		
Pulsed Drain Current $t_p = 10 \mu s$		I _{DM}	800	mA		
Operating Junction and Storage Temperature		_T _J ,	-55 to	°C		
		T _{STG}	150			
Source Current (Body Diode) (Note 2)		I _S	200	mA		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

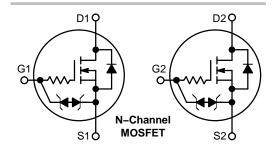
- Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.
- 2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%



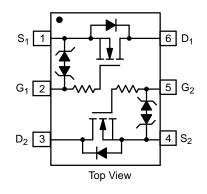
ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D Max
	1.5 Ω @ 4.5 V	
20 V	2.0 Ω @ 2.5 V	0.22 A
	3.0 Ω @ 1.8 V	
	4.5 Ω @ 1.5 V	



PINOUT: SOT-963







3 = Specific Device Code

M = Date Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 3)	P	1000	°C/W
Junction-to-Ambient - t = 5 s (Note 3)	$\kappa_{ heta$ JA	600	O/VV

^{3.} Surface-mounted on FR4 board using the minimum recommended pad size, 1 oz Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		20			V
Zero Gate Voltage Drain Current		V 0VV 5V	T _J = 25°C			50	nA
	I _{DSS}	$V_{GS} = 0 \text{ V}, V_{DS} = 5 \text{ V}$	T _J = 85°C			200	^
		V _{GS} = 0 V, V _{DS} = 16 V	$T_J = 25^{\circ}C$			100	nA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5.0 \text{ V}$				±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	0.4		1.0	V
Drain-to-Source On Resistance		$V_{GS} = 4.5 \text{ V}, I_D = 100 \text{ mA}$			0.75	1.5	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 50 \text{ mA}$			1.0	2.0	
	R _{DS(ON)}	V _{GS} = 1.8 V, I _D = 20 mA			1.4	3.0	
		V _{GS} = 1.5 V, I _D = 10 mA			1.8	4.5	
		V _{GS} = 1.2 V, I _D =	1.0 mA		2.8		
Forward Transconductance	9FS	V _{DS} = 5.0 V, I _D = 125 mA			0.48		S
Source-Drain Diode Voltage	V_{SD}	$V_{GS} = 0 \text{ V, } I_{S} = 10 \text{ mA}$			0.6	1.0	V
CAPACITANCES	•						
Input Capacitance	C _{ISS}	f = 1.0 MHz, V _{GS} = 0 V V _{DS} = 15 V			12.5		
Output Capacitance	C _{OSS}				3.6		pF
Reverse Transfer Capacitance	C _{RSS}				2.6		
SWITCHING CHARACTERISTICS, V _{GS} = 4	1.5 V (Note 4)	•			-		
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2.0 Ω			16.5		
Rise Time	t _r				25.5		ns
Turn-Off Delay Time	t _{d(OFF)}				142		
Fall Time	t _f				80		

 $^{{\}bf 4.} \ \ {\bf Switching\ characteristics\ are\ independent\ of\ operating\ junction\ temperatures.}$

ORDERING INFORMATION

Device	Package	Shipping [†]
NTUD3170NZT5G	SOT-963 (Pb-Free)	8000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

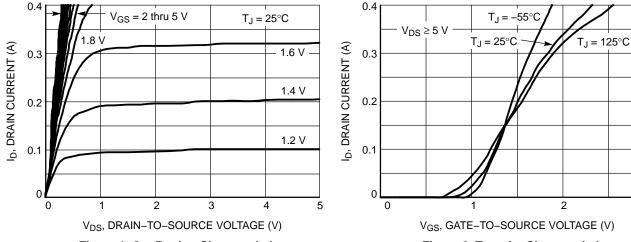


Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics

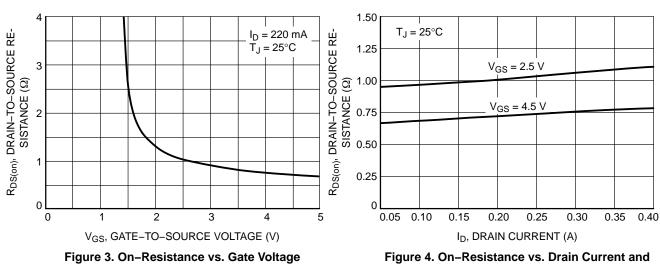


Figure 3. On-Resistance vs. Gate Voltage

1.75

1.50

1.25

1.00

0.75

0.50

-50

 $I_D = 100 \text{ mA}$ $V_{GS} = 4.5 \text{ V}$

R_{DS(on)}, DRAIN-TO-SOURCE RE-SISTANCE (NORMALIZED)

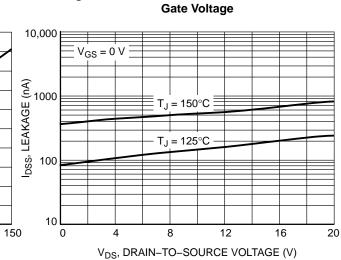


Figure 5. On-Resistance Variation with

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

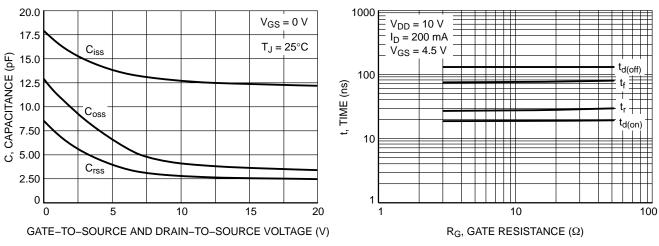


Figure 7. Capacitance Variation

Figure 8. Resistive Switching Time Variation vs. Gate Resistance

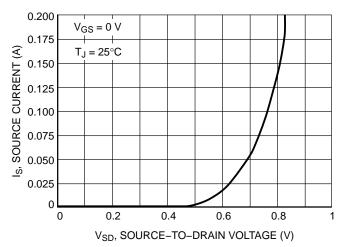
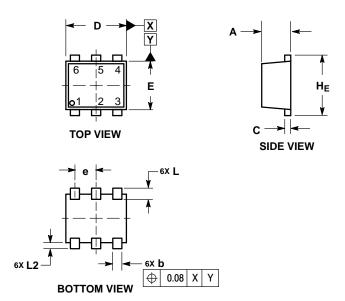


Figure 9. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

SOT-963 CASE 527AD ISSUE E

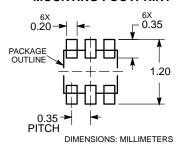


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.34	0.37	0.40	
b	0.10	0.15	0.20	
ပ	0.07	0.12	0.17	
D	0.95	1.00	1.05	
Е	0.75	0.80	0.85	
е	0.35 BSC			
HE	0.95	1.00	1.05	
L	0.19 REF			
L2	0.05	0.10	0.15	

RECOMMENDED MOUNTING FOOTPRINT



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